

In re application of: Shien-Ping HUANG

Serial No.: 09/665,818

Group No.: 2814

Filed: September 20, 2000

Examiner: Farahani, Dana

For:

SEMICONDUCTOR PACKAGE FOR

ENHANCING HEAT DISSIPATION

Attorney Docket No.: U 013803-1

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

AMENDMENT

In response to the Official Action of May 29, 2003, it is requested that the following amendments be made.

CERTIFICATE OF MAILING (37 CFR 1.8a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to the: Commissioner of Patents and Trademarks, Washington, D.C. 20231

Date: August 28, 2003

JULIAN H. COHEN

(Type or print name of person mailing paper)

(Signature of person mailing paper)